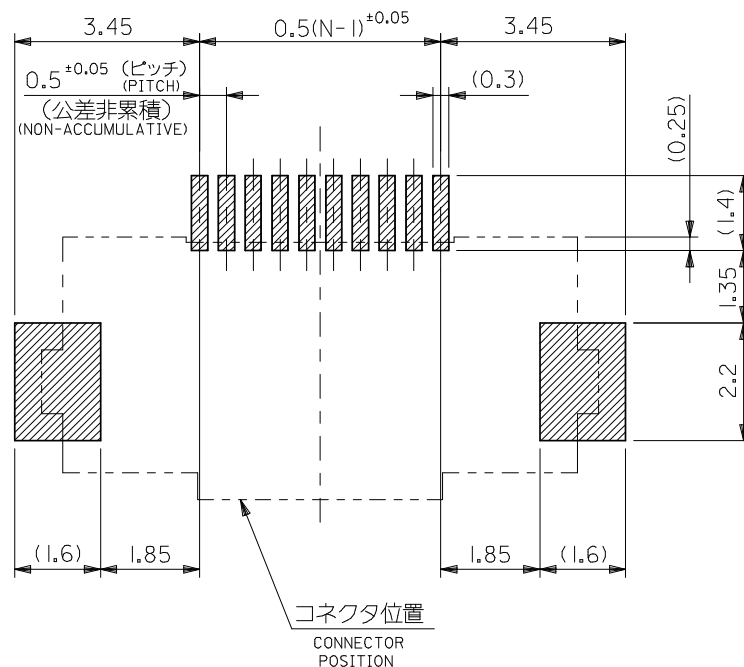


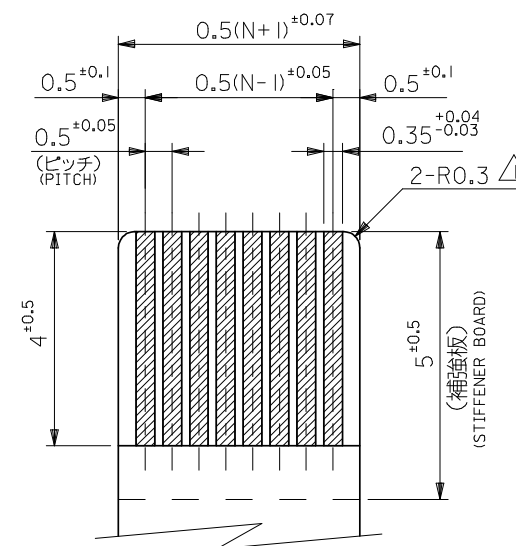


参考基板レイアウト
RECOMMENDED P.C.BOARD
PATTERN DIMENSION (REF.)

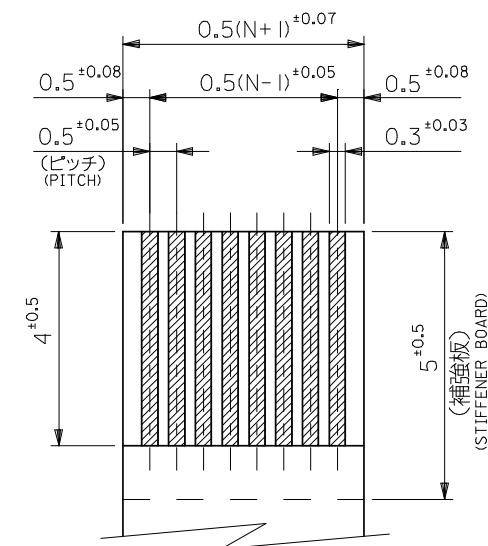
(マウント面)
(MOUNTING SIDE)

注記 NOTES

- △ R0.3は、FPCの導体部にかからないこと。
R0.3 MUST NOT BE OVERLAPPED TO PATTERN OF FPC.



適合FPC推奨寸法
APPLICABLE FPC
RECOMMENDED DIMENSION
(仕上がり厚さ: 0.3 ± 0.03)
(THICKNESS: 0.3 ± 0.03)



適合FFC推奨寸法
APPLICABLE FFC
RECOMMENDED DIMENSION
(仕上がり厚さ: $0.3^{+0.03}$)
(THICKNESS: $0.3^{+0.03}$)

2. FPCについて：

打抜き方向は導体側から補強板側を推奨致します。
補強フィルム材質はポリイミドを推奨致します。
接着剤は熱硬化接着剤を推奨致します。

ABOUT FPC

RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER BOARD SIDE.

RECOMMENDED MATERIAL:

STIFFENER FILM : POLYIMIDE
BONDING AGENT : THERMOSETTING BONDING AGENT

REVISED EC NO: J2008-4308 DRWN: NABEI CH'KD: THARYAMA APPR: NUKITA	DESCRIPTION 2008/06/27 2008/06/30 2008/06/30	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY M. NABEI	DATE 2004/01/09	TITLE 0.5 FPC CONN ASSY ZIF SMT RA(BTM CONT) E/O -LEAD FREE-				
		10 OVER 30 UNDER	± 0.25	CHECKED BY M. SASAO	DATE 2004/01/09					
		30 OVER	± 0.3	APPROVED BY M. SASAO	DATE 2004/01/09					
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-52892-040		2 OF 3		
	REV		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

10 9 8 7 6 5 4 3 2 1

F

E

D

C

B

A

F

E

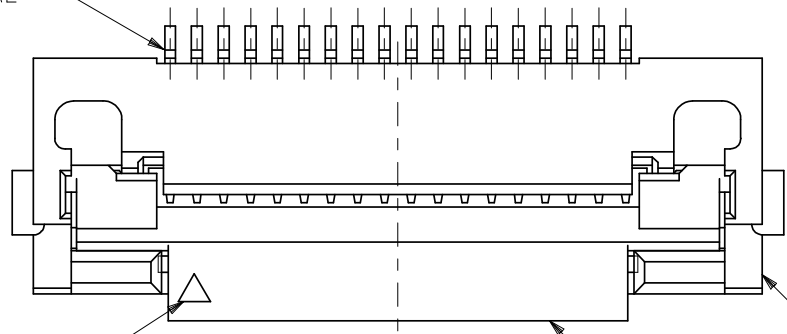
D

C

B

A

ターミナル
TERMINAL

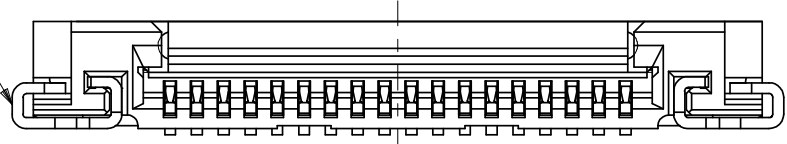


回路番号1側マーク
CKT.NO. 1 SIDE MARK

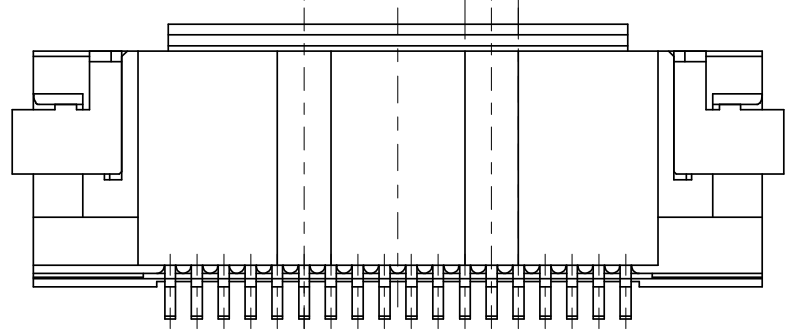
金具
FITTING NAIL

アクチュエータ
ACTUATOR

ハウジング
HOUSING



3.5
TYP.(2)

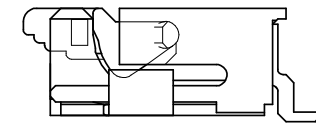


金型変更に伴う形状変更品形状図

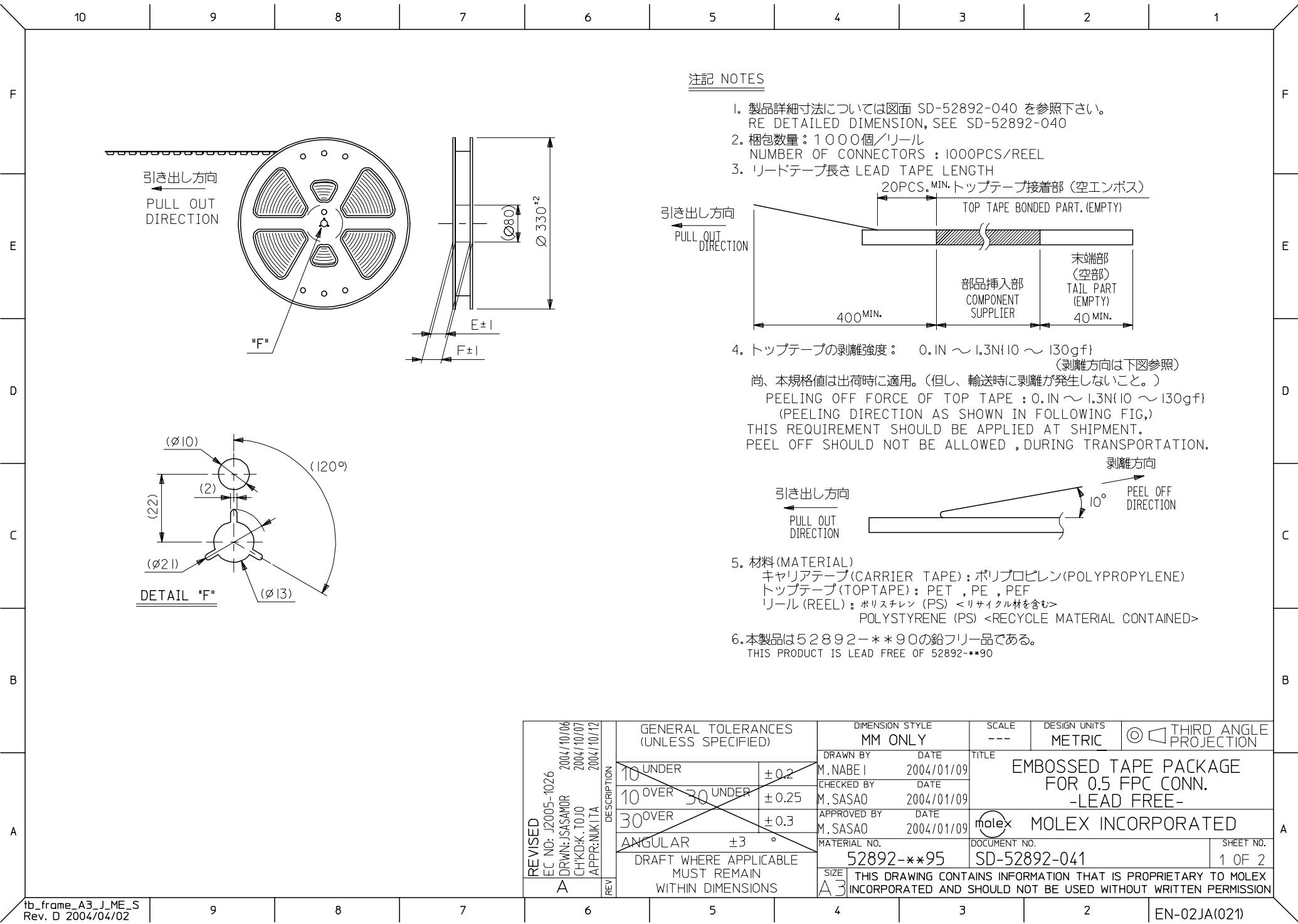
APPLY CHANGED FORM AT CHANGED DIE

注記 NOTES

△ 18極以上は2ヶ所、10～16極はハウジングセンター上に1ヶ所とする。
18 CKTS & MORE THAN 18 CKTS PLACED 2 POINT.
10 ~16 CKTS PLACED 1 POINT ON HOUSING CENTER.



REVISED EC NO: J2008-4308 DRWN:WABEI 2008/06/27 CHKD:THARUYAMA 2008/06/30 APPR:NUKITA 2008/06/30 B	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---		DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	
		10 UNDER	± 0.2	DRAWN BY M. NABEI		DATE 2004/01/09		TITLE 0.5 FPC CONN ASSY ZIF SMT RA(BTM CONT) E/O -LEAD FREE-			
		10 OVER 30 UNDER	± 0.25	CHECKED BY M. SASAO		DATE 2004/01/09					
		30 OVER	± 0.3	APPROVED BY M. SASAO		DATE 2004/01/09		MOLEX MOLEX INCORPORATED			
		ANGULAR ±3 °		MATERIAL NO. SEE SHEET 1		DOCUMENT NO. SD-52892-040					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							



REVISED EC NO: J2005-1026 2004/10/06 DRWN: ISASAMOR CHKD: TOJO 2004/10/07 APPR: NUKITA 2004/10/12 A	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER		± 0.2	DRAWN BY M. NABEI		DATE 2004/01/09	TITLE EMBOSSD TAPE PACKAGE FOR 0.5 FPC CONN. -LEAD FREE-		
		10 OVER 30 UNDER		± 0.25	CHECKED BY M. SASAO		DATE 2004/01/09			
		30 OVER		± 0.3	APPROVED BY M. SASAO		DATE 2004/01/09	MOLEX MOLEX INCORPORATED		
		ANGULAR		$\pm 3^\circ$	MATERIAL NO. 52892-**-95		DOCUMENT NO. SD-52892-041			
		REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

